## **Product Specification**

(Preliminary)

Part Name: OEL Display Module Part ID: UG-5664ASGGF01

Doc No.: SAS1-E024-A

Sustomer.
Approved by
From:
Approved by
Approved by

电话: 18601955397 QQ:2984664835 淘宝网店: https://shop73023976.taobao.com

## Revised History

Part Number	Revision	Revision Content	Revised on
UG-5664ASGGF01	A	New	August 25, 2009

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#### 1.1 Display Specifications

1) Display Mode: Passive Matrix

2) Display Color: Monochrome (Green / 16 Gray Scales)

3) Drive Duty: 1/64 Duty

#### 1.2 Mechanical Specifications

1) Outline Drawing: According to the annexed outline drawing

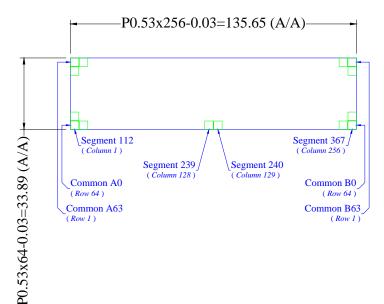
2) Number of Pixels:  $256 \times 64$ 

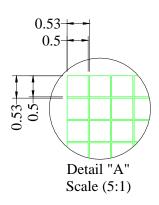
3) Panel Size:  $146.00 \times 45.00 \times 2.00 \text{ (mm)}$ 

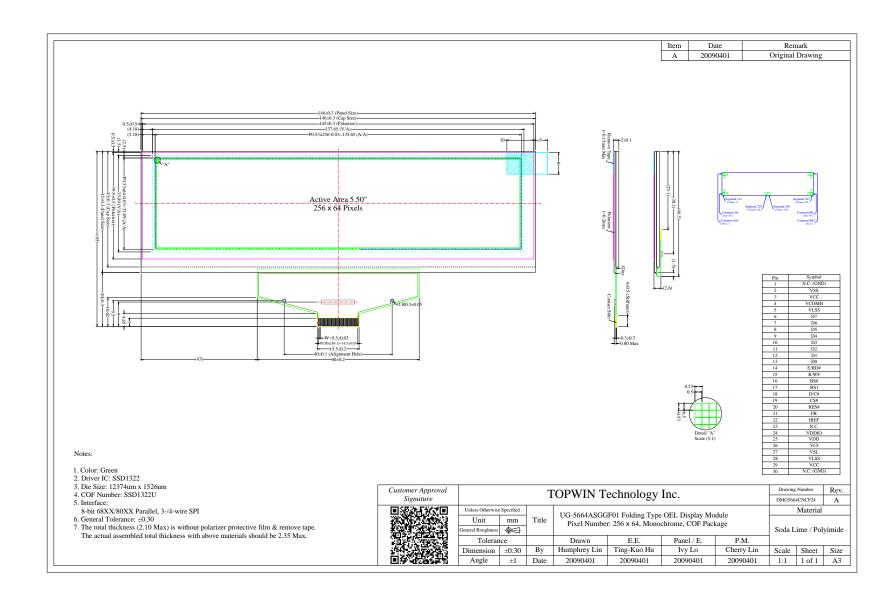
4) Active Area: 135.65 × 33.89 (mm) 5) Pixel Pitch: 0.53 × 0.53 (mm) 6) Pixel Size: 0.50 × 0.50 (mm)

7) Weight: 27.1 (g)

#### 1.3 Active Area & Pixel Construction







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## 1.5 Pin Definition

Pin Number	Symbol	Type	Function
Power Supply	y		
26	VCI	P	Power Supply for Operation  This is a voltage supply pin. It must be connected to external source & always be equal to or higher than VDD & VDDIO.
25	VDD	P	Power Supply for Core Logic Circuit  This is a voltage supply pin. It can be supplied externally (within the range of 2.4~2.6V) or regulated internally from VCI. A capacitor should be connected between this pin & VSS under all circumstances.
24	VDDIO	P	Power Supply for I/O Pin  This pin is a power supply pin of I/O buffer. It should be connected to VDD or external source. All I/O signal should have VIH reference to VDDIO. When I/O signal pins (BS0~BS1, D0~D7, control signals) pull high, they should be connected to VDDIO.
2	VSS	P	Ground of Logic Circuit  This is a ground pin. It also acts as a reference for the logic pins. It must be connected to external ground.
3, 29	VCC	P	Power Supply for OEL Panel  These are the most positive voltage supply pin of the chip. They must be connected to external source.
5, 28	VLSS	P	Ground of Analog Circuit  These are the analog ground pins. They should be connected to VSS externally.
Driver			
22	IREF	I	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10uA.
4	VCOMH	P	Voltage Output High Level for COM Signal  This pin is the input pin for the voltage output high level for COM signals. A tantalum capacitor should be connected between this pin and VSS.
27	VSL	P	Voltage Output Low Level for SEG Signal This is segment voltage reference pin. When external VSL is not used, this pin should be left open. When external VSL is used, this pin should connect with resistor and diode to ground.
Testing Pads			
21	FR	О	Frame Frequency Triggering Signal  This pin will send out a signal that could be used to identify the driver status. Nothing should be connected to this pin. It should be left open individually.

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## 1.5 Pin Definition (Continued)

Pin Number	Symbol	I/O	Function		
Interface					
16 17	BS0 BS1	I	Communicating Protocol Select These pins are MCU interface select following table:  3-wire SPI 4-wire SPI 8-bit 68XX Parallel 8-bit 80XX Parallel	BSO 1 0 1 0	BS1 0 0 1 1 1
20	RES#	I	Power Reset for Controller and This pin is reset signal input. W initialization of the chip is executed.		oin is low,
19	CS#	I	Chip Select This pin is the chip select input. The MCU communication only when CS#		
18	D/C#	I	Data/Command Control This pin is Data/Command control p pulled high, the input at D7~D0 is tre When the pin is pulled low, the inp transferred to the command reg relationship to MCU interface signal Timing Characteristics Diagrams.	eated as di ut at D7~ gister.	isplay data. D0 will be For detail
14	E/RD#	I	Read/Write Enable or Read This pin is MCU interface input. V 68XX-series microprocessor, this pin Enable (E) signal. Read/write operat this pin is pulled high and the CS# is When connecting to an 80XX-micr receives the Read (RD#) signal. D initiated when this pin is pulled low low. When serial mode is selected, this pi to VSS.	n will be used in will be used in its init pulled low roprocessor at a read of word CS:	used as the iated when v. or, this pin operation is # is pulled
15	R/W#	I	Read/Write Select or Write This pin is MCU interface input. V 68XX-series microprocessor, this p Read/Write (R/W#) selection input "High" for read mode and pull it mode. When 80XX interface mode is select the Write (WR#) input. Data write when this pin is pulled low and the C When serial mode is selected, this pi to VSS.	t. Pull to "Low"  cted, this poperation is pulled.	be used as his pin to 'for write pin will be is initiated ed low.
6~13	D7~D0	I/O	Host Data Input/Output Bus  These pins are 8-bit bi-direction connected to the microprocessor's da mode is selected, D1 will be the set and D0 will be the serial clock input Unused pins must be connected to V serial mode.	ta bus. V rial data i SCLK.	When serial nput SDIN

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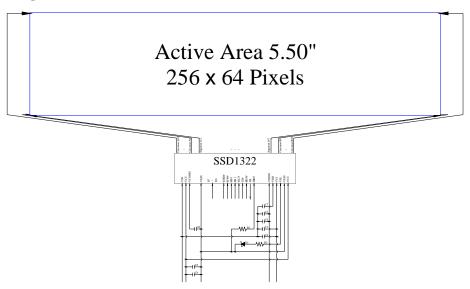
## 1.5 Pin Definition (Continued)

Pin Number	Symbol	I/O	Function
Reserve			
23	N.C.	-	Reserved Pin The N.C. pin between function pins are reserved for compatible and flexible design.
1, 30	N.C. (GND)	-	Reserved Pin (Supporting Pin)  The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.

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#### 1.6 Block Diagram



MCU Interface Selection: BS0 and BS1

Pins connected to MCU interface: D7~D0, E/RD#, R/W#, D/C#, CS#, and RES#

 $C1, C3, C5: 0.1\mu F$   $C2, C4: 4.7\mu F$   $C6: 20\mu F$  $C7: 1\mu F$ 

C8: 4.7uF / 25V Tantalum Capacitor

R1:  $910k\Omega$ , R1 = (Voltage at IREF – VSS) / IREF

R2: 50Ω, 1/4W D1: ≤1.4V, 0.5W

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#### 2. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Operation	$V_{CI}$	-0.3	4	V	1, 2
Supply Voltage for Logic	$V_{ m DD}$	-0.5	2.75	V	1, 2
Supply Voltage for I/O Pins	$V_{\mathrm{DDIO}}$	-0.5	$V_{CI}$	V	1, 2
Supply Voltage for Display	$V_{CC}$	-0.5	16	V	1, 2
Operating Current for V <sub>CC</sub>	$I_{CC}$	_	80	mA	1, 2
Operating Temperature	$T_{OP}$	-30	70	°C	_
Storage Temperature	$T_{STG}$	-40	80	°C	_

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

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#### 3. Optics & Electrical Characteristics

#### 3.1 Optics Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Brightness	$L_{br}$	With Polarizer (Note 3)	60	80	-	cd/m <sup>2</sup>
C.I.E. (Green)	(x)	Without Polarizer	0.27	0.31	0.35	
C.I.L. (Green)	(y)		0.58	0.62	0.66	
Dark Room Contrast	CR		-	>2000:1	-	
View Angle			>160	_	_	degree

<sup>\*</sup> Optical measurement taken at  $V_{CI} = 2.8V$ ,  $V_{CC} = 15V$ . Software configuration follows Section 4.4 Initialization.

#### 3.2 DC Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Operation	$V_{\text{CI}}$		2.4	2.8	3.5	V
Supply Voltage for Logic	$V_{DD}$		2.4	2.5	2.6	V
Supply Voltage for I/O Pins	$V_{\text{DDIO}}$		1.65	1.8	$V_{CI}$	V
Supply Voltage for Display	$V_{CC}$	Note 3	14.5	15	15.5	V
High Level Input	$V_{\text{IH}}$		$0.8 \times V_{DDIO}$	_	$V_{DDIO}$	V
Low Level Input	$V_{\mathrm{IL}}$		0	_	$0.2 \times V_{DDIO}$	V
High Level Output	$V_{OH}$	$I_{out} = 100 \mu A, 3.3 MHz$	0.9×V <sub>DDIO</sub>	_	$V_{DDIO}$	V
Low Level Output	$V_{OL}$	$I_{out} = 100 \mu A, 3.3 MHz$	0	_	$0.1 \times V_{DDIO}$	V
Operating Current for V <sub>CI</sub>	$I_{CI}$		_	1.8	2.25	mA
Operating Company for V	т	Note 4	_	39.8	49.8	mA
Operating Current for V <sub>CC</sub>	$I_{CC}$	Note 5	_	64.0	80.0	mA
Sleep Mode Current for V <sub>CI</sub>	I <sub>CI, SLEEP</sub>		_	1	5	μΑ
Sleep Mode Current for V <sub>CC</sub>	I <sub>CC, SLEEP</sub>		_	1	5	μΑ

Note 3: Brightness (L<sub>br</sub>) and Supply Voltage for Display (V<sub>CC</sub>) are subject to the change of the panel characteristics and the customer's request.

Note 4:  $V_{CI} = 2.8V$ ,  $V_{CC} = 15V$ , 50% Display Area Turn on.

Note 5:  $V_{CI} = 2.8V$ ,  $V_{CC} = 15V$ , 100% Display Area Turn on.

<sup>\*</sup> Software configuration follows Section 4.4 Initialization.

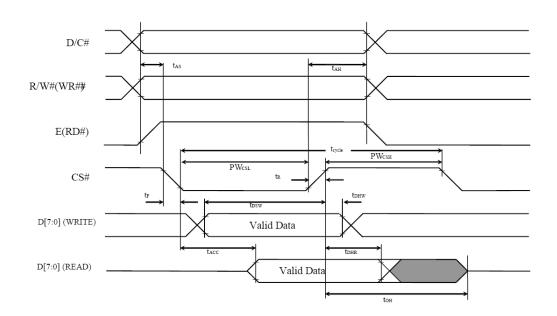
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#### 3.3 AC Characteristics

#### 3.3.1 68XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
$t_{ m cycle}$	Clock Cycle Time	300	-	ns
$t_{AS}$	Address Setup Time	10	-	ns
$t_{AH}$	Address Hold Time	0	-	ns
$t_{ m DSW}$	Write Data Setup Time	40	-	ns
$t_{ m DHW}$	Write Data Hold Time	7	-	ns
$t_{ m DHR}$	Read Data Hold Time	20	_	ns
t <sub>OH</sub>	Output Disable Time	_	70	ns
$t_{ACC}$	Access Time	_	140	ns
$PW_{CSL}$	Chip Select Low Pulse Width (Read)	120		ns
1 W CSL	Chip Select Low Pulse Width (Write)	60	_	115
$PW_{CSH}$	Chip Select High Pulse Width (Read)	60		ne
I W CSH	Chip Select High Pulse Width (Write)	60	_	ns
$t_R$	Rise Time	_	15	ns
$t_{ m F}$	Fall Time	_	15	ns

<sup>\*</sup>  $(V_{DD} - V_{SS} = 2.4 \text{V to } 2.6 \text{V}, V_{DDIO} = 1.6 \text{V}, V_{CI} = 2.8 \text{V}, T_a = 25^{\circ}\text{C})$ 



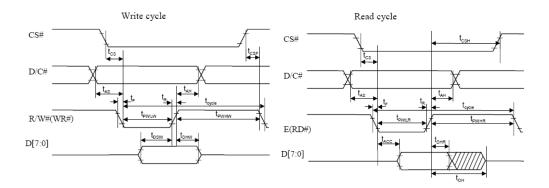
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## 3.3.2 80XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t <sub>cycle</sub>	Clock Cycle Time	300	-	ns
t <sub>AS</sub>	Address Setup Time	10	_	ns
$t_{AH}$	Address Hold Time	0	_	ns
$t_{ m DSW}$	Write Data Setup Time	40	_	ns
$t_{ m DHW}$	Write Data Hold Time	7	_	ns
$t_{ m DHR}$	Read Data Hold Time	20	-	ns
t <sub>OH</sub>	Output Disable Time	_	70	ns
$t_{ACC}$	Access Time	_	140	ns
$t_{\mathrm{PWLR}}$	Read Low Time	150	_	ns
$t_{PWLW}$	Write Low Time	60	_	ns
t <sub>PWHR</sub>	Read High Time	60	_	ns
$t_{\mathrm{PWHW}}$	Write High Time	60	_	ns
$t_{CS}$	Chip Select Setup Time	0	_	ns
$t_{CSH}$	Chip Select Hold Time to Read Signal	0	-	ns
t <sub>CSF</sub>	Chip Select Hold Time	20	-	ns
$t_{R}$	Rise Time	_	15	ns
$t_{\mathrm{F}}$	Fall Time	_	15	ns

\*  $(V_{DD} - V_{SS} = 2.4 \text{V to } 2.6 \text{V}, V_{DDIO} = 1.6 \text{V}, V_{CI} = 2.8 \text{V}, T_a = 25 ^{\circ}\text{C})$ 



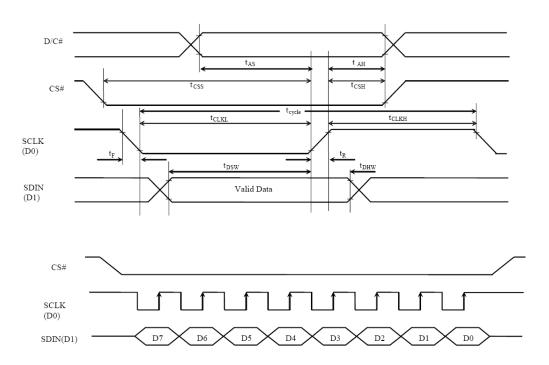
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## 3.3.3 Serial Interface Timing Characteristics: (4-wire SPI)

Symbol	Description	Min	Max	Unit
$t_{ m cycle}$	Clock Cycle Time	100	-	ns
$t_{AS}$	Address Setup Time	15	-	ns
t <sub>AH</sub>	Address Hold Time	15	_	ns
t <sub>CSS</sub>	Chip Select Setup Time	20	_	ns
t <sub>CSH</sub>	Chip Select Hold Time	10	-	ns
$t_{ m DSW}$	Write Data Setup Time	15	_	ns
$t_{ m DHW}$	Write Data Hold Time	15	-	ns
$t_{CLKL}$	Clock Low Time	20	_	ns
$t_{CLKH}$	Clock High Time	20	_	ns
$t_{R}$	Rise Time	_	15	ns
$t_{\mathrm{F}}$	Fall Time	_	15	ns

\*  $(V_{DD} - V_{SS} = 2.4 \text{V to } 2.6 \text{V}, V_{DDIO} = 1.6 \text{V}, V_{CI} = 2.8 \text{V}, T_a = 25^{\circ}\text{C})$ 



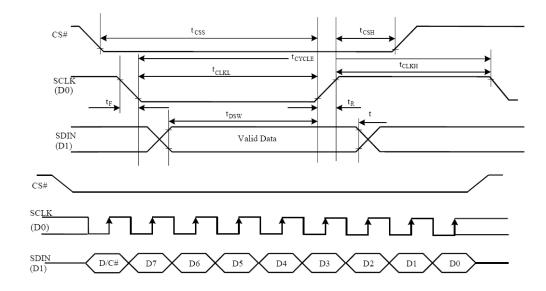
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## 3.3.4 Serial Interface Timing Characteristics: (3-wire SPI)

Symbol	Description	Min	Max	Unit
$t_{ m cycle}$	Clock Cycle Time	100	-	ns
$t_{AS}$	Address Setup Time	15	-	ns
$t_{AH}$	Address Hold Time	15	-	ns
t <sub>CSS</sub>	Chip Select Setup Time	20	-	ns
t <sub>CSH</sub>	Chip Select Hold Time	10	-	ns
$t_{ m DSW}$	Write Data Setup Time	15	-	ns
$t_{ m DHW}$	Write Data Hold Time	15	_	ns
$t_{CLKL}$	Clock Low Time	20	-	ns
$t_{CLKH}$	Clock High Time	20	-	ns
$t_R$	Rise Time	_	15	ns
$t_{\mathrm{F}}$	Fall Time	<b>-</b>	15	ns

\*  $(V_{DD} - V_{SS} = 2.4 \text{V to } 2.6 \text{V}, V_{DDIO} = 1.6 \text{V}, V_{CI} = 2.8 \text{V}, T_a = 25 ^{\circ}\text{C})$ 



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#### 4. Functional Specification

#### 4.1. Commands

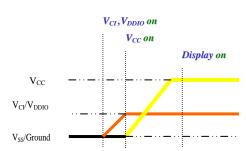
Refer to the Technical Manual for the SSD1322

#### 4.2 Power down and Power up Sequence

To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.

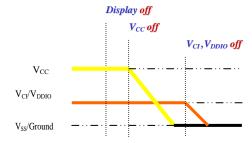
#### 4.2.1 Power up Sequence:

- 1. Power up  $V_{CI} \& V_{DDIO}$
- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5. Power up  $V_{CC}$
- 6. Delay 100ms (When V<sub>CC</sub> is stable)
- 7. Send Display on command



#### 4.2.2 Power down Sequence:

- 1. Send Display off command
- 2. Power down V<sub>CC</sub>
- 3. Delay 100ms (When V<sub>CC</sub> is reach 0 and panel is completely discharges)
- 4. Power down V<sub>CI</sub> & V<sub>DDIO</sub>



#### 4.3 Reset Circuit

When RES# input is low, the chip is initialized with the following status:

- 1. Display is OFF
- 2. 480×128 Display Mode
- 3. Normal segment and display data column and row address mapping (SEG0 mapped to column address 00h and COM0 mapped to row address 00h)
- 4. Display start line is set at display RAM address 0
- 5. Column address counter is set at 0
- 6. Normal scan direction of the COM outputs
- 7. Contrast control registers is set at 7Fh

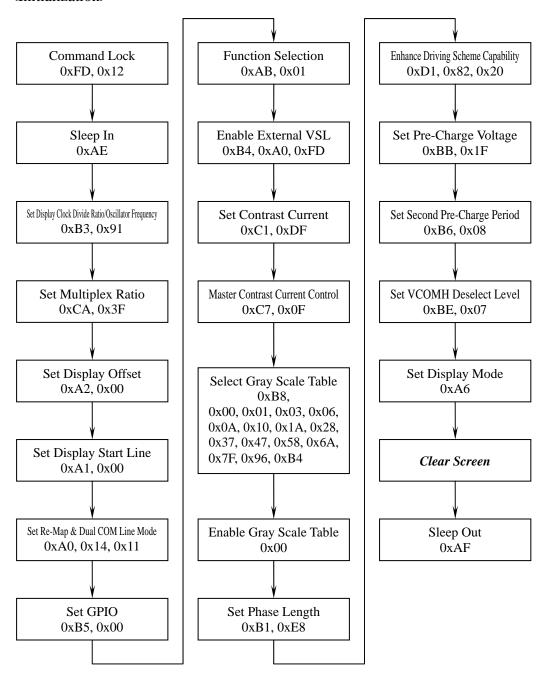
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#### 4.4 Actual Application Example

Command usage and explanation of an actual example

#### <Initialization>



If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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#### 5. Reliability

#### 5.1 Contents of Reliability Tests

Item	Conditions	Criteria	
High Temperature Operation	70°C, 240 hrs		
Low Temperature Operation	-30°C, 240 hrs		
High Temperature Storage	80°C, 240 hrs	The operational	
Low Temperature Storage	-40°C, 240 hrs	functions work.	
High Temperature/Humidity Storage	60°C, 90% RH, 120 hrs		
Thermal Shock	-40°C ⇔ 85°C, 24 cycles 60 mins dwell		

<sup>\*</sup> The samples used for the above tests do not include polarizer.

#### 5.2 Lifetime

End of lifetime is specified as 50% of initial brightness reached.

Parameter	Min	Max	Unit	Condition	Notes
Operating Life Time	40,000	1	hr	80 cd/m <sup>2</sup> , 50% Checkerboard	6

Note 6: The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

#### 5.3 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.

<sup>\*</sup> No moisture condensation is observed during tests.

#### 6. Outgoing Quality Control Specifications

#### 6.1 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

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Temperature:  $23 \pm 5$ °C Humidity:  $55 \pm 15 \% RH$ 

Fluorescent Lamp: 30W Distance between the Panel & Lamp: ≥ 50 cm Distance between the Panel & Eyes of the Inspector: ≥ 30 cm

Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic.

#### 6.2 Sampling Plan

Level II, Normal Inspection, Single Sampling, MIL-STD-105E

#### 6.3 Criteria & Acceptable Quality Level

Partition	AQL	Definition
Major	0.65	Defects in Pattern Check (Display On)
Minor	1.0	Defects in Cosmetic Check (Display Off)

#### 6.3.1 Cosmetic Check (Display Off) in Non-Active Area

Check Item	Classification	Criteria
Panel General Chipping	Minor	X > 10 mm (Along with Edge) Y > 1.5 mm (Perpendicular to edge)

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## 6.3.1 Cosmetic Check (Display Off) in Non-Active Area (Continued)

Check Item	Classification	Criteria
CHECK ITEM	Ciassification	Cineria
Panel Crack	Minor	Any crack is not allowable.
Cupper Exposed (Even Pin or Film)	Minor	Not Allowable by Naked Eye Inspection
Film or Trace Damage	Minor	This pool of the second
Glue or Contamination on Pin (Couldn't Be Removed by Alcohol)	Minor	
Terminal Lead Prober Mark	Acceptable	
Ink Marking on Back Side of panel (Exclude on Film)	Acceptable	Ignore for Any

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## 6.3.2 Cosmetic Check (Display Off) in Active Area

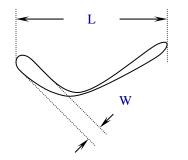
It is recommended to execute in clear room environment (class 10k) if actual in necessary.

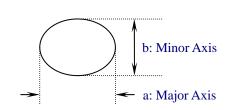
in necessary.			
Check Item	Classification	Criteria	
Any Dirt & Scratch on	Accentable	Ignore for not Af	fect the
Polarizer's Protective Film	Acceptable	Polarizer	
Scratches, Fiber, Line-Shape		$W \le 0.1$	Ignore
Defect	Minor	$W > 0.1, L \le 2$	$n \le 1$
(On Polarizer)		L > 2	n = 0
Dirt, Black Spot, Foreign		$\Phi \leq 0.1$	Ignore
Material,	Minor	$0.1 < \Phi \le 0.25$	$n \le 1$
(On Polarizer)		Minor         Polarizer $W \le 0.1$ $W > 0.1$ , $L \le 2$ $L > 2$ $D \le 0.1$ Minor $0.1 < \Phi \le 0.25$ $0.25 < \Phi$ $\Phi \le 0.5$	
		$\Phi \leq 0.5$	
		→ Ignore if no Inf	fluence on
		Display	
		$0.5 < \Phi$	n = 0
Dent, Bubbles, White spot	N. 4.		
(Any Transparent Spot on	Minor		
Polarizer)			
		W ≤ 0.1 Ignore W > 0.1, L ≤ 2 $n ≤ 1L > 2$ $n = 0Φ ≤ 0.1$ Ignore 0.1 < Φ ≤ 0.25 $n ≤ 10.25 < Φ$ $n = 0Φ ≤ 0.5→ Ignore if no Influence onDisplay0.5 < Φ$ $n = 0$	
Fingerprint, Flow Mark	N 4°	NT 4 A 11 1	1
(On Polarizer)	Minor	Not Allowab	oie

- \* Protective film should not be tear off when cosmetic check.
- \*\* Definition of W & L & Φ (Unit: mm):

$$\Phi = (a+b)/2$$

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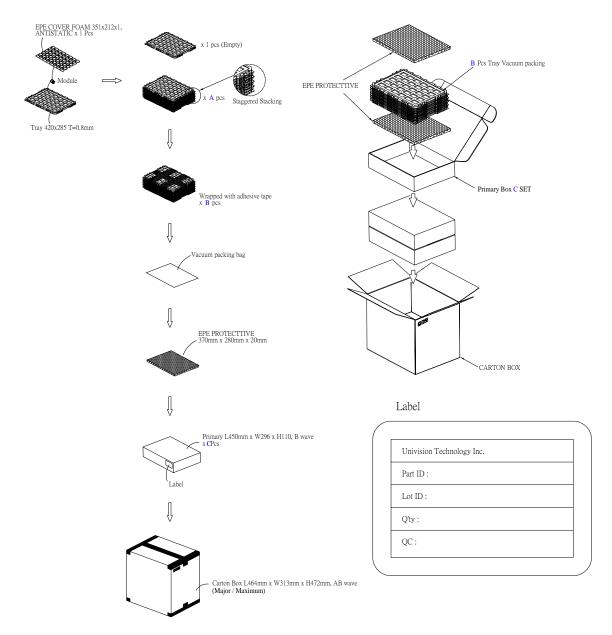
## 6.3.3 Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	
Un-uniform	Major	

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## 7. Package Specifications



Item			Quantity
Holding Trays	(A)	15	per Primary Box
Total Trays	(B)	16	per Primary Box (Including 1 Empty Tray)
Primary Box	(C)	1~4	per Carton (4 as Major / Maximum)

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#### 8. Precautions When Using These OEL Display Modules

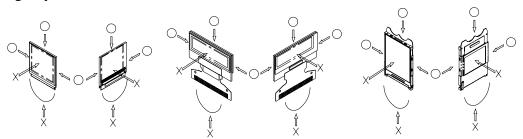
#### 8.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- \* Water
- \* Ketone
- \* Aromatic Solvents
- 6) Hold OEL display module very carefully when placing OEL display module into the system housing. Do not apply excessive stress or pressure to OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the LSI chips and the surrounding molded sections.
- 8) Do not disassemble nor modify the OEL display module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
  - \* Be sure to make human body grounding when handling OEL display modules.
  - \* Be sure to ground tools to use or assembly such as soldering irons.
  - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
  - \* Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes

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the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).

12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

#### 8.2 Storage Precautions

- 1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from TOPWIN Technology Inc.)
  - At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

#### **8.3 Designing Precautions**

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OEL display module, fasten the external plastic housing section.
- 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1322
  - \* Connection (contact) to any other potential than the above may lead to rupture of the IC.

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### 8.4 Precautions when disposing of the OEL display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.